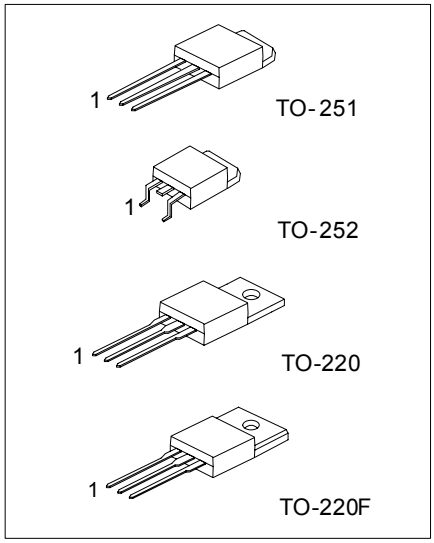
YR3410
Power MOSFET

15Amps, 100Volts
N-CHANNEL POWER MOSFET



*Pb-free plating product number: YR3410

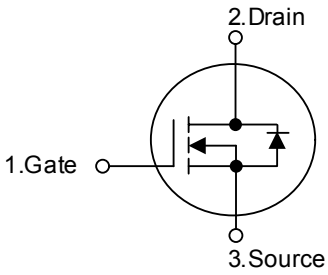
■ DESCRIPTION

The YR 3410 is a low voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and excellent avalanche characteristics. This power MOSFET is usually used at automotive applications in power supplies, high efficient DC to DC converters and battery operated products.

■ FEATURES

* $R_{DS(ON)}$ = 110m Ω @V_{GS} = 10 V
* Ultra low gate charge (typical 29 nC)
* Low reverse transfer Capacitance (C_{RSS} = typical 65 pF)
* Fast switching capability
* 100% avalanche energy specified
* Improved dv/dt capability

■ SYMBOL



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current[1]	T_C = 25 °C	I_D	15	A
	T_C = 100 °C		10	
Pulsed Drain Current[2]		I_{DM}	60	
Avalanche Current		I_{As}	24	
Avalanche Energy	L = 0.1mH	E_{AS}	30	mJ
Power Dissipation	T_C = 25 °C	P_D	50	W
	T_C = 100 °C		20	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$		50	

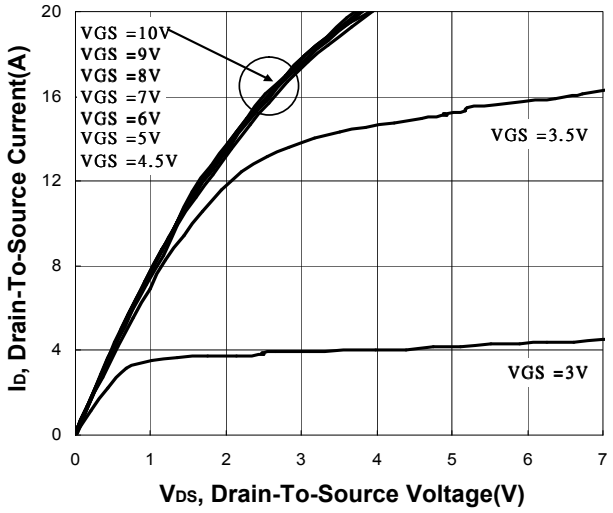
[1]Pulse width limited by maximum junction temperature.
[2]Limited by package

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

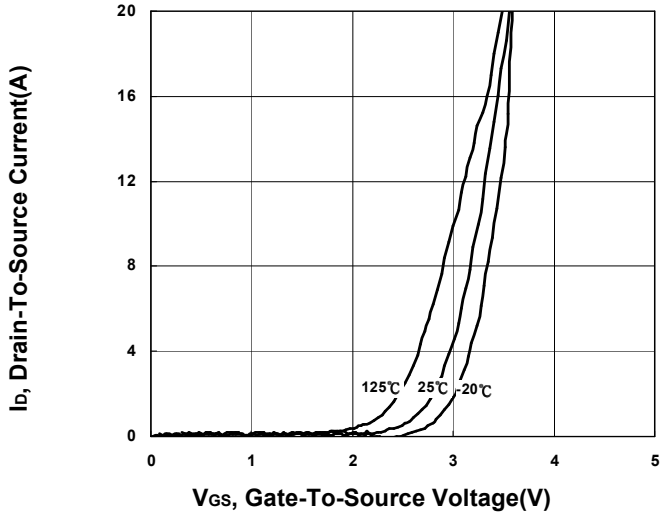
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	100			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1	2	3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 80V, V_{GS} = 0V			1	μA
		V_{DS} = 80V, V_{GS} = 0V, T_J = 125 °C			10	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 10V, V_{GS} = 10V	60			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 6A		92	120	mΩ
		V_{GS} = 10V, I_D = 12A		87	110	mΩ
Forward Transconductance[1]	g_{fs}	V_{DS} = 10V, I_D = 12A		40		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		1400		pF
Output Capacitance	C_{oss}			103		
Reverse Transfer Capacitance	C_{rss}			65		
Total Gate Charge[2]	Q_g	V_{DS} =50V, V_{GS} = 10V, I_D = 12A		29		nC
Gate-Source Charge[2]	Q_{gs}			4		
Gate-Drain Charge[2]	Q_{gd}			9		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DD} = 50V, I_D ≅ 12A, V_{GS} = 10V, R_{GS} = 6Ω		8		nS
Rise Time[2]	t_r			170		
Turn-Off Delay Time[2]	$t_{d(off)}$			32		
Fall Time[2]	t_f			75		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I_S				15	A
Forward Voltage[1]	V_{SD}	I_F = 12, V_{GS} = 0V			1.4	V
Reverse Recovery Time	t_{rr}	I_F = 12 A, dI_F/dt = 100A / μS		26		nS
Reverse Recovery Charge	Q_{rr}			17		nC

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.

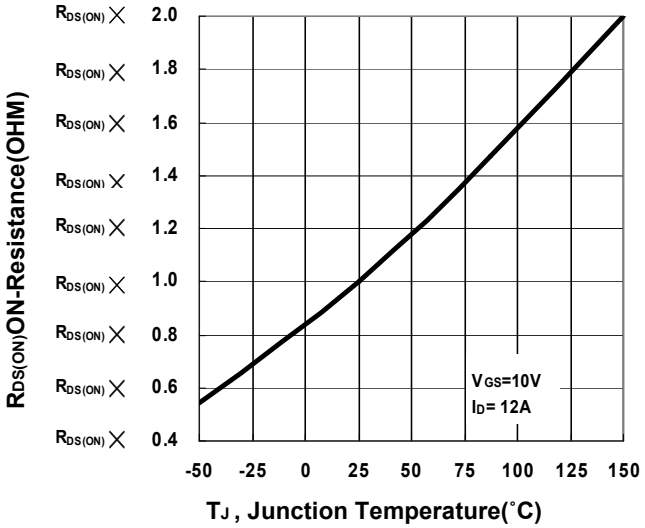
Output Characteristics



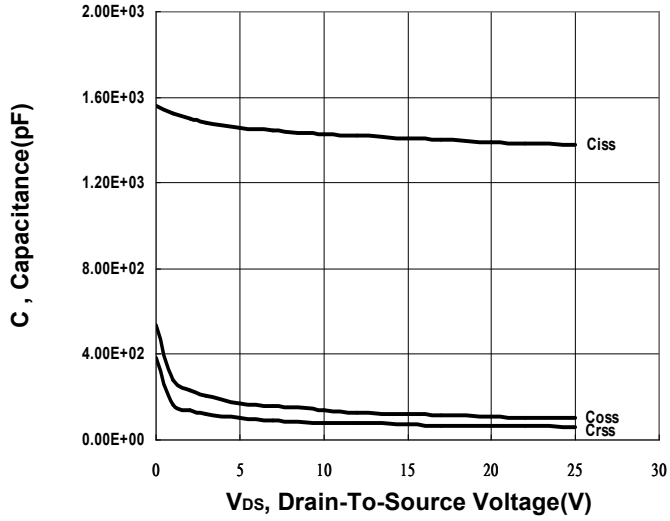
Transfer Characteristics



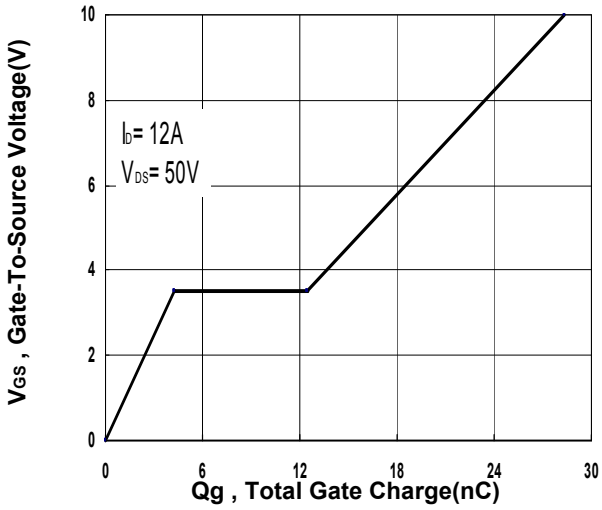
On-Resistance VS Temperature



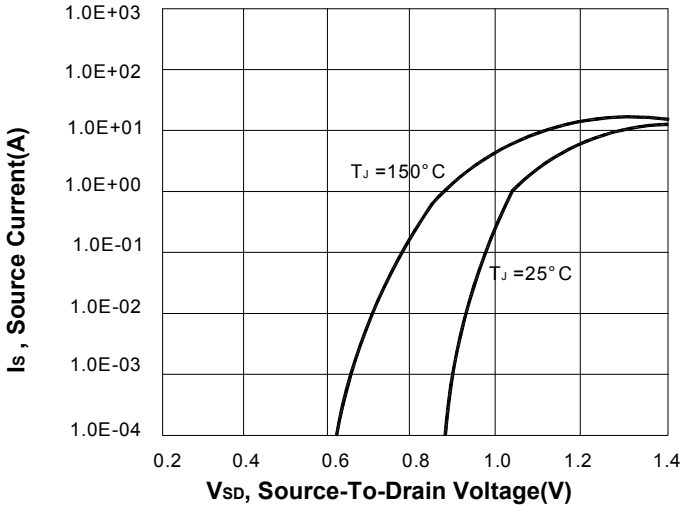
Capacitance Characteristic



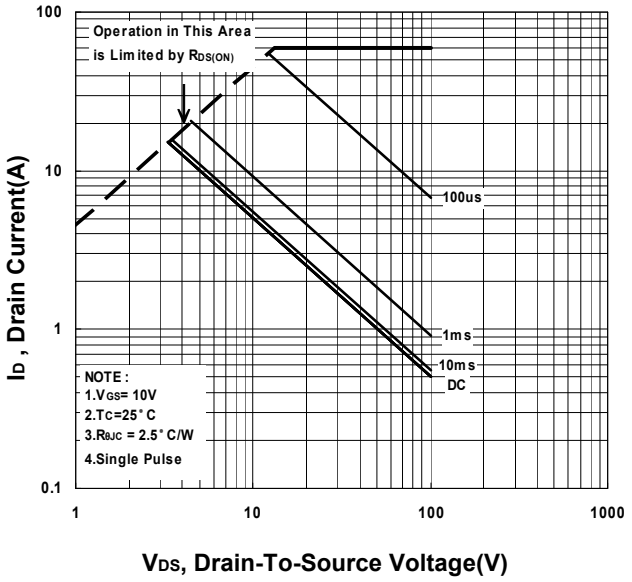
Gate charge Characteristics



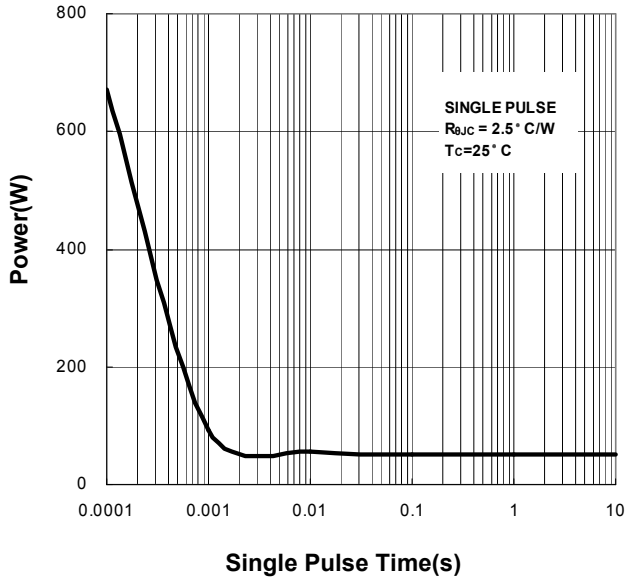
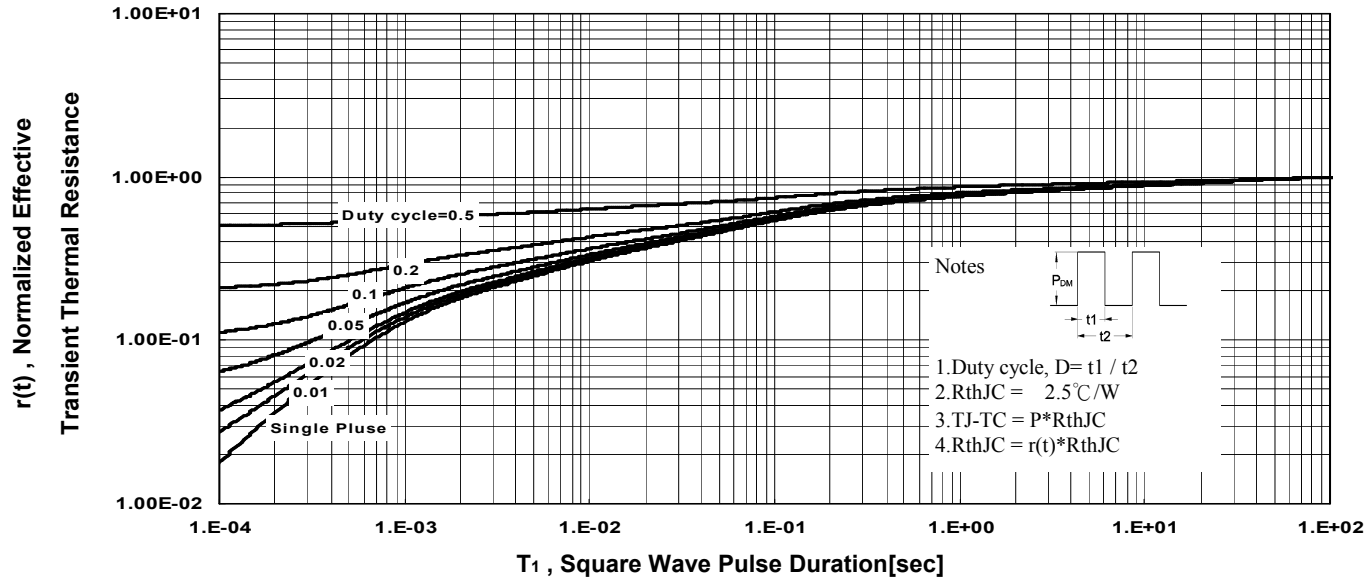
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve